

High Efficiency Regulator Controller

FEATURES

- Complete Control for a High Current, Low Dropout, Linear Regulator
- Fixed 5V or Adjustable Output Voltage
- Accurate 2.5A Current Limiting with Foldback
- Internal Current Sense Resistor
- Remote Sense for Improved Load Regulation
- External Shutdown
- Under-Voltage Lockout and Reverse Voltage Protection
- Thermal Shutdown Protection
- 8 Pin Mini-Dip Package (Surface Mount also Available)

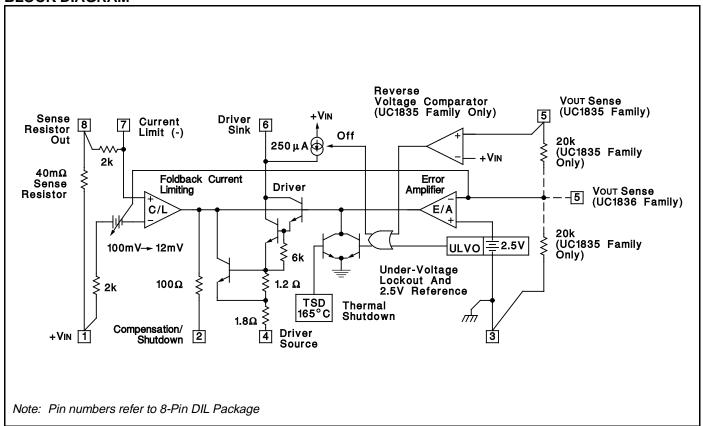
DESCRIPTION

The UC1835/6 families of linear controllers are optimized for the design of low cost, low dropout, linear regulators. Using an external pass element, dropout voltages of less than 0.5V are readily obtained. These devices contain a high gain error amplifier, a 250mA output driver, and a precision reference. In addition, current sense with foldback provides for a 2.5A peak output current dropping to less than 0.5A at short circuit.

These devices are available in fixed, 5V, (UC1835), or adjustable, (UC1836), versions. In the fixed 5 volt version, the only external parts required are an external pass element, an output capacitor, and a compensation capacitor. On the adjustable version the output voltage can be set anywhere from 2.5V to 35V with two external resistors.

Additional features of these devices include under-voltage lockout for predictable start-up, thermal shutdown and short circuit current limiting to protect the driver device. On the fixed voltage version, a reverse voltage comparator minimizes reverse load current in the event of a negative input to output differential.

BLOCK DIAGRAM

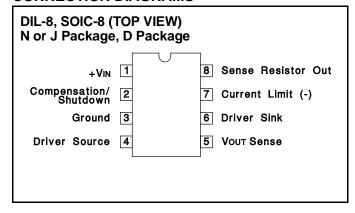


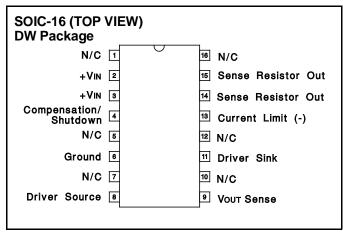
ABSOLUTE MAXIMUM RATINGS (Note 1)

Input Supply Voltage (+Vin)1.0V to + 40V	/
Driver Output Current (Sink or Source) 600m/	4
Driver Source to Sink Voltage + 40\	/
Maximum Current Through Sense Resistor	4
Vout Sense Input Voltage	/
Power Dissipation at TA = 25°C (Note 2) 1000mV	V
Power Dissipation at Tc = 25°C (Note 2) 2000mV	V

Operating Junction Temperature -55°C to +150°C Storage Temperature -65°C to +150°C Lead Temperature (Soldering, 10 Seconds) 300°C Note 1: Voltages are referenced to ground, (Pin 3). Currents are positive into, negative out of, the specified terminals. Consult Packaging Section of Databook for thermal considerations and limitations of packages.

CONNECTION DIAGRAMS





PLCC-20, LCC-20				
(TOP VIEW)	PACKAGE PIN FUNCTION			
Q, L Packages	FUNCTION	PIN		
	N/C	1		
	+VIN	2		
	+VIN	3		
0.010010	N/C	4		
3 2 1 20 19 18	Compensation/ Shutdown	5		
[5 17]	N/C	6		
6 16	Ground	7		
7 15	N/C	8		
8 14	N/C	9		
9 10 11 12 13	Driver Source	10		
	N/C	11		
	Vout Sense	12		
	N/C	13		
	N/C	14		
	Driver Sink	15		
	N/C	16		
	Current Limit (-)	17		
	N/C	18		
	Sense Resistor Out	19		
	Sense Resistor Out	20		

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, specifications hold for TA = 0°C to + 70°C for the UC3835/6, -25°C to + 85°C for the UC2835/6, and -55°C to +125°C for the UC1835/6, +VIN = 6V, Driver Source= 0V, Driver Sink = 5V, TA = TJ.

PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Supply		•			
Supply Current	+VIN = 6V		2.75	4.0	mA
	+VIN = 40V		3.75	6.0	mA
UVLO Threshold	+VIN Low to High, VOUT Sense = 0V	3.9	4.4	4.9	V
Threshold Hysteresis			0.1	0.35	V
Reverse Current	+VIN = -1.0V, Driver Sink Open		6.0	20	mA
Regulating Voltage and Error Amplifier (UC	C1835 Family Only)				
Regulating Level at Vout Sense (VREG)	Driver Current = 10mA, TJ = 25°C	4.94	5.0	5.06	V
	Over Temperature	4.9		5.1	V
Line Regulation	+VIN = 5.2V + 35V		15	40	mV
Load Regulation	Driver Current = 0 to 250mA		6.0	25	mV
Bias Current at Vou⊤ Sense	Vout Sense = 5.0V	75	125	210	μΑ
Error Amp Transconductance	±100μA at Compensation/Shutdown Pin	0.8	1.3	2.0	mS
Maximum Compensation Output Current	Sink or Source, Driver Source Open	90	200	260	μΑ

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, specifications hold for Ta = 0°C to + 70°C for the UC3835/6, -25°C to + 85°C for the UC2835/6, and -55°C to +125°C for the UC1835/6, +VIN = 6V, Driver Source= 0V, Driver Sink = 5V, Ta = TJ.

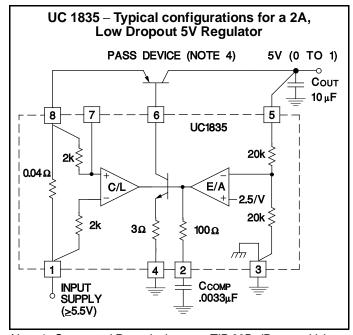
PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Regulating Voltage and Error Amplifier (UC1	836 Family Only)				
Regulating Level at VouT Sense (VREG)	Driver Current = 10mA, T _J = 25°C	2.47	2.5	2.53	V
	Over Temperature	2.45		2.55	V
Line Regulation	+VIN = 5.2V to 35V		6.0	20	mV
Load Regulation	Driver Current = 0 to 250mA		3.0	15	mV
Bias Current at Vout Sense	Vout Sense =2.5V	-1.0	-0.2		μΑ
Error Amp Transconductance	±100μA at Compensation/Shutdown Pin	0.8	1.3	2.0	mS
Maximum Compensation Output Current	Sink or Source, Driver Source Open	90	200	260	μΑ
Driver					
Maximum Current		250	500		mA
Saturation Voltage	Driver Current = 250mA, Driver Sink		2.0	2.8	V
Pull-Up Current at Driver Sink	Compensation/Shutdown=0.45V	140	250	300	μΑ
Driver Sink Leakage	In UVLO			10	μΑ
	In Reverse Voltage (UC1835 Family Only)			10	μΑ
Thermal Shutdown			165		°C
Foldback Current Limit		_			_
Current Limit Levels at Sense Resistor Out	Vout Sense = (0.99) VREG	2.2	2.5	2.8	Α
	Vout Sense = (0.5) VREG	1.3	1.5	1.7	Α
	Vout Sense = 0V	0.25	0.4	0.55	Α
Current Limit Amp Tansconductance	±100μA at Compensation/Shutdown, Vout Sense = (0.9) VREG	12	24	42	mS
Limiting Voltage at Current Limit (-) (Note 2)	Vout Sense = (0.9) VREG Volts Below +VIN, TJ = 25°C	80	100	140	mV
Sense Resistor Value (Note 3)	V _{OUT} Sense = (0.9) V _{REG} , I _{OUT} = I _A , T _J = 25°C		40		mΩ

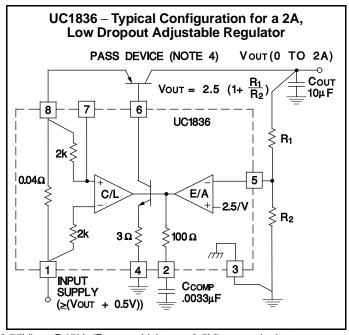
Note 2: This voltage has a positive temperature coefficient of approximately 3500ppm/°C.

Note 3: This resistance has a positive temperature coefficient of approximately 3500ppm/°C.

The total resistance from Pin 1 to Pin 8 will include an additional 60 to $100m\Omega$ of package resistance.

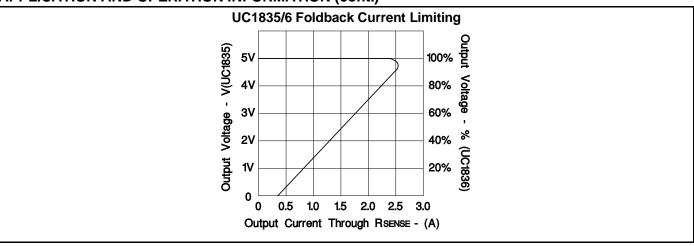
APPLICATION AND OPERATION INFORMATION





Note 4: Suggested Pass devices are TIP 32B. (Dropout Voltage ≤0.75V) or, D45H, (Dropout Voltage ≤0.5V), or equivalents.

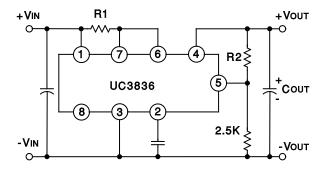
APPLICATION AND OPERATION INFORMATION (cont.)



UC3835/36 TYPICAL APPLICATIONS

Low Current Application

using the UC3836 internal drive transistor



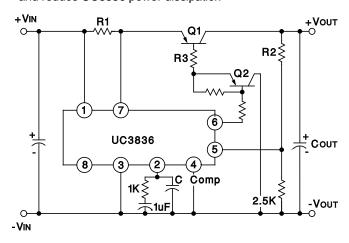
Typical Output Current vs Vin and Vout

of the UC3836 internal drive transistor for PDISS = 0.5W (approx.)

		Vin					
	Volts	5	9	12	15	18	24
	2	150	60	40	30	20	12
VOUT	5		105	55	35	25	15
• • • •	9			130	60	35	20
	12				120	55	25
	15	Current in mA 110					30

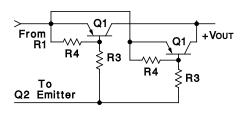
High Current Application

using drive transistor Q2 to increase Q1 base drive and reduce UC3836 power dissipation



Parallel Pass Transistors

can be added for high current or high power dissipation applications



EQUATIONS:

R1 = 0.100 V/Iout (MAX)

 $R_2 = (VOUT - 2.5V/1mA)$

R3 = ((VIN - VBE - VSAT)*BETA(min))/IOUT (max)

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
5962-9065002PA	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9065002PA UC1836
UC1836J	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1836J
UC1836J.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1836J
UC1836J883B	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9065002PA UC1836
UC1836J883B.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9065002PA UC1836
UC2835D	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2835D
UC2835D.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2835D
UC2836D	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2836D
UC2836D.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	See UC2836D	UC2836D
UC2836DG4	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2836D
UC3836D	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3836D
UC3836D.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3836D

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF UC1836, UC3836:

Catalog: UC3836

Military: UC1836

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
UC2835D	D	SOIC	8	75	506.6	8	3940	4.32
UC2835D.A	D	SOIC	8	75	506.6	8	3940	4.32
UC2836D	D	SOIC	8	75	506.6	8	3940	4.32
UC2836D.A	D	SOIC	8	75	506.6	8	3940	4.32
UC2836DG4	D	SOIC	8	75	506.6	8	3940	4.32
UC3836D	D	SOIC	8	75	506.6	8	3940	4.32
UC3836D.A	D	SOIC	8	75	506.6	8	3940	4.32

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